

On-detector particle identification at the HL-LHC

Stefania Bufalino INFN and Politecnico of Torino On behalf of the LHC Collaborations



HL-LHC an amazing opportunity







HL-LHC an amazing opportunity



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HL-LHC challenges

The HL-LHC will have about x3 instantaneous and x10 integrated luminosity, requiring detector upgrades to

- deal with enhanced pileup interaction and radiation damage levels
- improve the experiment for better discovery potential and measurement precision

One such collision every 25 ns at HL-LHC



Talk on CMS Upgrade by T. Fernandez on June ^{6th}

S. Bufalino -On-detector particle identification at the HL-LHC

Talk on ATLAS Upgrade by Y. Okumura onJune ^{6th}



Strategy 4D track and vertex reconstruction with per-particle precise timing



HL-LHC challenges

Physics programme limited by the detectors

- Use of timing is a key strategy to overcome challenges
- Improvement of **Particle IDentification** capabilities is **crucial for physics reach**



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dielectrons: TOF + RICH



The ALICE 3 upgrade

ALICE main goal: access the dynamics of the strongly interacting matter produced in heavy-ion collisions





- Fundamental questions will remain open after
 LHC Run 4, demanding for a next heavy-ion
 generation experiment
- Letter of Intent submitted in March 2022 ALICE CERN-LHCC-2022-009
- Scoping document submission this year



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The ALICE 3 detector

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Physics	Observable
Early stages	Dilepton and photon production and flow
HQ thermalization diffusion	Heavy flavours correlations and flow
Hadronization	Multi-charm baryons, quarkonia
Detector requirements	Pointing resolution: $\approx 10 \ \mu m$ at 200 MeV/c
	Large pseudorapodity coverage: $ \eta < 4$
	Extensive Particle IDentification
	Tracking relative p_T resolution $\approx 1-2\%$
	Forward Conversion Tracker (FCT): photons with $1 < p_T < 50$ MeV at $\eta > 4$

ALICE 3 charged PID system

- Time-Of-Flight
- Ring-Imaging Cherenkov
- EM Calorimeter
- Muon Identifier Detector



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- THIS TALK

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ALICE 3 TOF implementation

- iTOF & oTOF (barrel) + 2 forward disks
- Inner TOF at $R \approx 0.19$ m, |z| < 0.62 m
- Outer TOF at $R \approx 0.85$ m, |z| < 3.50 m
- Forward TOF at $z \pm 3.70$ m, |R| < 1.0 m







ALICE 3 TOF PID



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ALICE 3 TOF R&D



- Timing resolution of ~ 30 ps demonstrated with 50 µm up to (1-2)10¹⁵ 1-MeV-neq/cm²
- thinner LGADs produced by different manifacturers

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- Timing resolution of 40 ps for single photons detection so far
- Very promising results on MIP detection



- Low material budget
- High SNR
- Low power
- Investigation on innovative design to proof timing performance





ALICE 3 TOF RED



simulations show that with 25 µm thickness an intrinsic time resolution of 20 ps is feasible → first results from test beam

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Timing resolution of 40 ps

demonstrated with charged particles



Low material budge

R&D for the addition of a gain layer → extensive activities of sensor simulation and design



ALICE 3 TOF R&D: LGADS



 \rightarrow Improved performance for thinner LGADs

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ALICE 3 TOF R&D: LGADS





 \rightarrow Improved performance for thinner LGADs

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ALICE 3 TOF R&D: LGADS



First very thin LGAD prototypes produced by FBK

25 μm and **35 μm** -thick FBK single channel

Area = **1x1 mm**²



Standard sensors produced by HPK

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50 µm -thick HPK single channel (W42 & W36 with different doping concentrations)

Area = 1.3x1.3 mm²





Single and double LGADs



Single LGADs: comparable time resolution for a similar gain Better time resolution for a double-LGAD in respect to single ones (~15% for 25 µm & 24% for 35 µm)

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ALICE 3 TOF RED: CMOS-LGAD

ARCADIA pad sensor $HV_{n+} > 0$ Sensor pad Sensor pad Gain layer n-epi n-epi nwell pwell deep deep pwell pwell **High Resistivity Si High Resistivity Si** HV_{Backside} < 0

ARCADIA pad sensor with gain



- CMOS electronics in the pixel area
- Trade-off between electronics in pixel and timing
- AC coupling between sensor and electronics

Process: modified LFoundry CMOS 110nm with 3 different active thicknesses 50µm, 100µm and 200 µm **Process add-on:** gain layer implantation with moderate gain



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nwell



ALICE 3 TOF R&D: CMOS-LGAD



ARCADIA pad sensor with gain



Intrinsic timing resolution $\sigma_{Distortion}$ and $\sigma_{Landau noise}$

Transfer function: integrated amplifier designed by micro-electronics expert



- For improved timing resolution, the active thickness can be easily changed with **customized substrates**
- No need to change masks for the first run just- "fast track" option

ALICE 3 TOF R&D: CMOS-LGAD

First **prototype with integrated electronics** and gain layer produced by LFoundry in 110 nm commercial CMOS Process



Active thickness: 48 µm

- Presence of deep-p-wells hosting the front-end electronics
- \bullet Backside HV allows full depletion -25 V to -40 V
- \bullet Topside HV manages the gain 30 V to 50 V



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ALICE 3 RICH implementation

ALICE 3 RICH RED

Extend charged PID beyond TOF limits

- e/π up to $\approx 2 \text{ GeV}/c$ - π/K up to $\approx 10 \text{ GeV}/c$
- K/p up to $\approx 16 \text{ GeV}/c$

R&D challenges

- Projective bRICH to improve coverage at large $|\eta|$ while saving on overall photosensitive area
- Merged oTOF+bRICH system using a common SiPM layer coupled to a thin radiator window

MIP timing using bRICH SiPMs

Principle of operation

- Introduction of Cherenkov radiator coupled to SiPM layer
- Use SiPM clusters due to radiator photons for MIP timing

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Radiator choice

Use high refractive index material to minimize Cherenkov thresholds and to enhance both photon yield and spread

*MIP at 0° incidence

2 7*

Assuming PDE of S13360-**50CS SiPMs at recommended overvoltage

Beam test MIP timing using bRICH SiPMs

Available FBK NUV-HD-RH SiPM with different protection layers:

- Silicone Resin 1 mm (SR1) (n=1.5)
- Silicone Resin 1.5 mm (SR15)
- Epoxy Resin 1 mm (ER1) (n=1.53)
- Without resin (WR)
- Customized FE with 40 dB amplification

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Exploiting Cherenkov radiation in the protection layer the time resolution improves as a function of the number of fired SPADs, reaching **20 ps for six or more SPADs**

Eur. Phys. J. Plus 138, 788 (2023)

RICH: SiPM with radiator window

Test beam in Oct 2023 at CERN PS

- Aerogel radiator by Aerogel Factory LTD (Japan)
- 8x8 SiPM matrices from HPK and FBK, various pixel sizes
- Different radiator windows coupled to SiPM to test TOF+RICH integrated concept

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1.0 mrad 900 16153 Entries 800 874.7 ± 12.1 Pion Norm Data bkg Pion Mean 241.2 ± 0.0 700 entries / Pion Sigma 4.061 ± 0.038 600 585.1 ± 10.4 Prot Norm **500** Prot Mean 210.8 ± 0.1 đ Prot Sigma 3.765 ± 0.046 400 F Number Bkg Norm 0.1042 ± 0.0033 **300** ⊟ Preliminary 200 ALICE 3 study 100 260 280 300 320 340 220 240 200 Single hit angle [mrad] Time resolution [ps] -PRELIMINARY 250 200 150 100 50 ·••• •• 10 20 35 15 Number of photoelectrons

LHCb Phase II Upgrades

The ultimate flavour physics experiment at the HL-LHC

Physics Case for an LHCb Upgrade II

LHCC-2018-027

LHCC-2021-012

Technical Design Repor

Framework

IDCRAC

- Installation of a new time of flight detector (TORCH)
- No more hadron calorimeter
- Addition of timing information to cope with increased detector occupancy
- Physics programme relies on **good PID**: need to add timing to the Cherenkov photons (**RICH Upgrade**)

LHCb Phase II Upgrades: PID detectors

The ultimate flavour physics experiment at the HL-LHC

TORCH

- large area time of flight detector to provide PID in the GeV/c momentum range
- Exploit prompt production of Cherenkov light in a quartz radiator plate to provide a fast timing signal.
- Aim for a resolution of 10-15 ps per track

RICH Detectors

- Current detectors would have 100% occupancy
- Three-fold plan:
 - Adjust optics
 - Finer segmentation
 - Shift sensitivity towards green
- Possible time resolution of ~ 100 ps

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The LHCb RICH: timing information

90

100

Time distribution of photon hits within 25 ns shows clear Cherenkov peak signal

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When we were a constrained by the velocity of the velocity of

80

Kaon ID Efficiency / %

70

The LHCb RICH: test beam results

Need photodetectors with smaller pixel size ~ 1mm² Need time resolution better than 100 ps

The test beam campaign focuses on the development and testing of prototype readout chains with fast- timing information.

The LHCb TORCH

- Exploits prompt production of Cherenkov light in quartz bars
- Cherenkov photons travel to detector plane via total internal reflection
- MCP used as photodetector
- Provide PID below 15 GeV/c

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Test beam at CERN PS

half-scale (660 x1250 x10 mm³) TORCH demonstrator module

The LHCb TORCH

Test beam at CERN PS

half-scale (660 x1250 x10 mm³) TORCH demonstrator module

Timing resolution is approaching 70 ps/photon for beam entry position close to the MCP-PMT (red line)

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S. Bufalino -On-detector particle identification at the HL-LHC

- High luminosity running presents many challenges for experiments
- Exciting physics cases under study and PID detectors are cucial
- Use of timing also for PID is a key strategy to overcome challenges

ALICE 3

- robuts R&D for TOF measurement with 20 ps resolution
- breakthrough concept of TOF measurements using bRICH

LHCb

- RICH and TORCH: R&Ds are ongoing for detector designs and next-generation technologies
- the picosecond time information will add a new dimension to the experiment

12th Large Hadron Collider Physics al Conference 3-7, 2024 @ Northeastern University Ihcp2024.cos.northeastern.edu

THANK YOU